- Designed Specifically for High-Speed: Memory Decoders
   Data Transmission Systems
- Two Fully Independent 2- to 4-Line Decoders/Demultiplexers
- Schottky Clamped for High Performance

#### description

These Schottky-clamped TTL MSI circuits are designed to be used in high-performance memory-decoding or data-routing applications requiring very short propagation delay times. In high-performance memory systems, these decoders can be used to minimize the effects of system decoding. When employed with high-speed memories utilizing a fast-enable circuit, the delay times of these decoders and the enable time of the memory are usually less than the typical access time of the memory. This means that the effective system delay introduced by the Schottky-clamped system decoder is negligible.

The circuit comprises two individual two-line to four-line decoders in a single package. The active-low enable input can be used as a data line in demultiplexing applications.

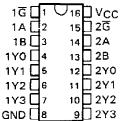
All of these decoders/demultiplexers feature fully buffered inputs, each of which represents only one normalized load to its driving circuit. All inputs are clamped with high-performance Schottky diodes to suppress line-ringing and to simplify system design. The SN54LS139A and SN54S139 are characterized for operation range of  $-55\,^{\circ}\text{C}$  to  $125\,^{\circ}\text{C}$ . The SN74LS139A and SN74S139A are characterized for operation from  $0\,^{\circ}\text{C}$  to  $70\,^{\circ}\text{C}$ .

#### **FUNCTION TABLE**

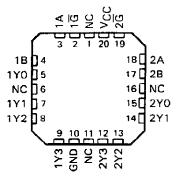
INP	UTS		OUTPUTS						
ENABLE	SEL	ECT							
G	В	Α	YO	Y1	Y2	Υ3			
Н	Х	Х	Н	Н	Н	Н			
Ļ	L	L	L	Н	Н	Н			
L	L	Н	Н	L	Н	Н			
L	н	L	н	н	L	Н			
L	Н	Н	Н	H	Н	L			

H = high level, L = low level, X = irrelevant

# SN54LS139A, SN54S139 . . . J OR W PACKAGE SN74LS139A, SN74S139A . . . D OR N PACKAGE (TOP VIEW)

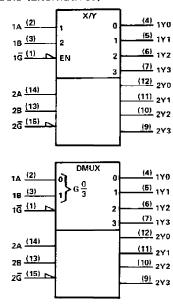


# \$N54L\$139A, \$N54\$139 . . . FK PACKAGE (TOP VIEW)



NC-No internal connection

#### logic symbols (alternatives)†



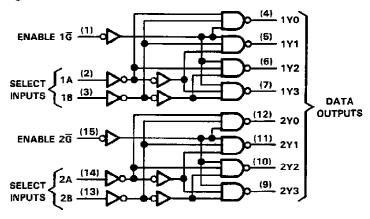
<sup>&</sup>lt;sup>†</sup>These symbols are in accordance with ANSI/IEEE Std. 91-1984 and IEC Publication 617-12.

Pin numbers shown are for D, J, N, and W packages.



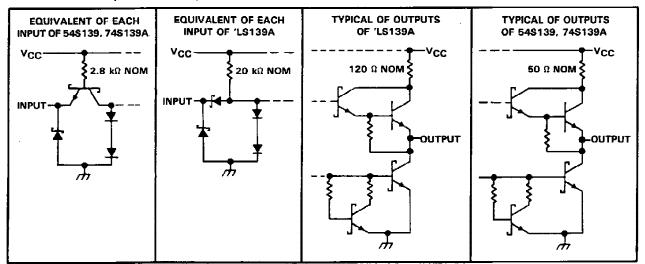
### SN54LS139A, SN54S139, SN74LS139A, SN74S139A DUAL 2-LINE TO 4-LINE DECODERS/DEMULTIPLEXERS

#### logic diagram (positive logic)



Pin numbers shown are for D, J, N, and W packages.

### schematics of inputs and outputs



#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

Supply voltage, VCC (See Note 1)
Input voltage: 'LS139A
54\$139, 74\$139A, 5.5 V
Operating free-air temperature range: SN54LS139A, SN54S13955°C to 125°C
SN74LS139A, SN74S139A 0° C to 70°C
Storage temperature range

NOTE 1: Voltage values are with respect to network ground terminal.

#### recommended operating conditions

		SN	154LS13	9A	SN	174LS13	9A	
		MIN	NOM	MAX	MIN	NOM	MAX	UNIT
Vcc	Supply voltage	4.5	5	5.5	4.75	5	5.25	V
$V_{IH}$	High-level input voltage	2			2			V
VIL	Low-level input voltage			0.7			0.8	V
ЮН	High-level output current			-0.4		-	-0.4	mA
loL	Low-level output current			4			8	mA
TA	Operating free-air temperature	- 55		125	0		70	ů

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDITIO	Ne†	SI	154LS13	9A	SI	74LS13	89A	
TANAMETER		TEST CONDITIO		MIN	TYP‡	MAX	MIN	TYP#	MAX	UNIT
VIK	V <sub>CC</sub> = MIN,				- 1.5			-1.5	V	
Voн	$V_{CC} = MIN,$ $I_{OH} = -0.4 \text{ mA}$	V <sub>IH</sub> = 2 V,	V <sub>IL</sub> = MAX,	2.5	3.4		2.7	3.4		٧
Vo	V <sub>CC</sub> = MIN,	V <sub>IH</sub> = 2 V,	I <sub>OL</sub> = 4 mA		0.25	0.4		0.25	0.4	
VOL	VIL = MAX		IOL = 8 mA		<del> · · · · · · · · · · · · · · · · · ·</del>			0.35	0.5	٧
ti .	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 7 V			=	0.1			0.1	mA
lін	VCC = MAX,	V <sub>1</sub> = 2.7 V	· · · · · · · · · · · · · · · · · · ·			20		***************************************	20	μА
I <sub>I</sub> L	V <sub>CC</sub> = MAX,	V <sub>1</sub> = 0.4 V				-0.4			-0.4	mA
los <sup>§</sup>	$V_{CC} = MAX$			- 20	-	- 100	- 20		100	mA
<sup>I</sup> cc	V <sub>CC</sub> = MAX,	Outputs enable	ed and open		6.8	11		6.8	11	mA

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

# switching characteristics, $V_{CC} = 5 \text{ V}$ , $T_A = 25 \,^{\circ}\text{C}$ (see Note 2)

PARAMETER¶	FROM ((NPUT)	TO (OUTPUT)	LEVELS OF DELAY	TEST CONDITIONS	1	SN54LS139A SN74LS139A		
		(00	OI DELA		MIN	TYP	MAX	]
tPLH_			2			13	20	ns
tPHL .	Binary		Any			22	33	ns
tPLH	Select	Ally		D. 240 C 15 -F		18	29	ns
<sup>t</sup> PHL			3	$R_L = 2 k\Omega$ , $C_L = 15 pF$		25	38	ns
t <b>P</b> LH	Enable	Any	2			16	24	ns
tPHL !	Lindbic					21	32	ns

<sup>1</sup> tpLH = propagation delay time, low-to-high-level output

tphL = propagation delay time, high-to-low-level output NOTE 2: Load circuits and voltage waveforms are shown in Section 1.

 $<sup>^{\</sup>ddagger}$ All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_{A} = 25 \,^{\circ}\text{C}$ .

Not more than one output should be shorted at a time, and duration of the short circuit test should not exceed one second.

# SN54S139, SN74S139A DUAL 2-LINE TO 4-LINE DECODERS/DEMULTIPLIERS

#### recommended operating conditions

		S	N54S1	39	SI	N74S13	9A	UNIT
		MIN	NOM	MAX	MIN	NOM	MAX	UNII
Vсс	Supply voltage	4.5	5	5.5	4.75	5	5.25	V
VIH	High-level input voltage	2			2			V
V <sub>IL</sub>	Low-level input voltage			0.8			0.8	V
편	High-level output current			<b>– 1</b>		·	- 1	mA
<u>o</u>	Low-level output current		-	20			20	mΑ
TΑ	Operating free-air temperature	-55		125	0		70	°C

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		ı	SN54S139 SN74S139A					
	<u> </u>				MIN	TYP‡	MAX	1
v <sub>IK</sub>	V <sub>CC</sub> = MIN,	lj = −18 mA					-1.2	V
	VCC = MIN,	V <sub>IH</sub> = 2 V,	V <sub>IL</sub> = 0.8 V,	SN54S'	2.5	3.4		v
∨он	I <sub>OH</sub> = -1 mA			SN74S'	2.7	3.4		)
VoL	V <sub>CC</sub> = MIN,	V <sub>!H</sub> = 2 V,	V <sub>IL</sub> = 0.8 V,				0.5	V
*OL	I <sub>OL</sub> = 20 mA						0.5	
i,	$V_{CC} = MAX$	$V_1 = 5.5 V$					1	mA
liH .	V <sub>CC</sub> = MAX,	$V_1 = 2.7 \text{ V}$					50	μА
I <sub>I</sub> ը	V <sub>CC</sub> = MAX,	$V_{  } = 0.5 V$					- 2	mA
los §	V <sub>CC</sub> = MAX				-40		-100	mA
'cc	V <sub>CC</sub> = MAX,	Outputs enable	ed and open			60	90	mA

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

 $^{\ddagger}$  All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25 °C.

## switching characteristics, $V_{CC} = 5 \text{ V}$ , $T_A = 25 \,^{\circ}\text{C}$ (see Note 2)

PARAMETER¶	FROM {INPUT}	TO (OUTPUT)	LEVELS OF DELAY	TEST CO	NDITIONS	1	SN54S139 SN74S139A		
	(INPO1)	(001701)	UP DELAY			MIN	TYP	MAX	1
tPLH			2				5	7.5	ns
<sup>t</sup> PHL	Binary		-		6.5	10	ns		
<sup>t</sup> PLH	Select	Any	3	] n 200 n	C 15 -5		7	12	ns
<sup>t</sup> PHL			3	$R_L = 280 \Omega,$	C[ = 15 pr		8	12	ns
tPLH	Enable	A	2	1			5	8	ns
tPHL	Enable	Any					6.5	10	ns

TtpLH = propagation delay time, low-to-high-level output

tpHL = propagation delay time, high-to-low-level output

NOTE 2: Load circuits and voltage waveforms are shown in Section 1.



<sup>§</sup> Not more than one output should be shorted at a time, and duration of the short circuit test should not exceed one second.



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## **PACKAGING INFORMATION**

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
76007012A	ACTIVE	LCCC	FK	20	55	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	76007012A SNJ54LS 139AFK	Samples
7600701EA	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	7600701EA SNJ54LS139AJ	Samples
7600701FA	ACTIVE	CFP	W	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	7600701FA SNJ54LS139AW	Samples
7700401EA	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	7700401EA SNJ54S139J	Samples
7700401FA	ACTIVE	CFP	W	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	7700401FA SNJ54S139W	Samples
JM38510/30702B2A	ACTIVE	LCCC	FK	20	55	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30702B2A	Samples
JM38510/30702BEA	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30702BEA	Samples
JM38510/30702BFA	ACTIVE	CFP	W	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30702BFA	Samples
JM38510/30702SEA	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30702SEA	Samples
JM38510/30702SFA	ACTIVE	CFP	W	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30702SFA	Samples
M38510/30702B2A	ACTIVE	LCCC	FK	20	55	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30702B2A	Samples
M38510/30702BEA	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30702BEA	Samples
M38510/30702BFA	ACTIVE	CFP	W	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30702BFA	Samples
M38510/30702SEA	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30702SEA	Samples
M38510/30702SFA	ACTIVE	CFP	W	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	JM38510/ 30702SFA	Samples
SN54LS139AJ	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54LS139AJ	Samples



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Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
SN54S139J	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	SN54S139J	Samples
SN74LS139AD	OBSOLETE	SOIC	D	16		TBD	Call TI	Call TI	0 to 70	LS139A	
SN74LS139ADR	ACTIVE	SOIC	D	16	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS139A	Samples
SN74LS139ADRE4	ACTIVE	SOIC	D	16	2500	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	LS139A	Samples
SN74LS139AN	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS139AN	Samples
SN74LS139ANE4	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74LS139AN	Samples
SN74LS139ANSR	ACTIVE	SO	NS	16	2000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	74LS139A	Samples
SN74S139AD	ACTIVE	SOIC	D	16	40	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	0 to 70	S139A	Samples
SN74S139AN	ACTIVE	PDIP	N	16	25	RoHS & Green	NIPDAU	N / A for Pkg Type	0 to 70	SN74S139AN	Samples
SNJ54LS139AFK	ACTIVE	LCCC	FK	20	55	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	76007012A SNJ54LS 139AFK	Samples
SNJ54LS139AJ	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	7600701EA SNJ54LS139AJ	Samples
SNJ54LS139AW	ACTIVE	CFP	W	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	7600701FA SNJ54LS139AW	Samples
SNJ54S139J	ACTIVE	CDIP	J	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	7700401EA SNJ54S139J	Samples
SNJ54S139W	ACTIVE	CFP	W	16	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	7700401FA SNJ54S139W	Samples

<sup>(1)</sup> The marketing status values are defined as follows: **ACTIVE:** Product device recommended for new designs.

**LIFEBUY:** TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

**PREVIEW:** Device has been announced but is not in production. Samples may or may not be available.

**OBSOLETE:** TI has discontinued the production of the device.

<sup>(2)</sup> RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

PACKAGE OPTION ADDENDUM

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RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

**Green:** TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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#### OTHER QUALIFIED VERSIONS OF SN54LS139A, SN54LS139A-SP, SN74LS139A:

Catalog: SN74LS139A, SN54LS139A

Military: SN54LS139A

Space: SN54LS139A-SP

NOTE: Qualified Version Definitions:

Catalog - TI's standard catalog product

Military - QML certified for Military and Defense Applications

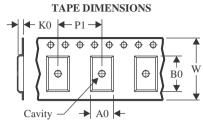
• Space - Radiation tolerant, ceramic packaging and qualified for use in Space-based application

# **PACKAGE MATERIALS INFORMATION**

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### TAPE AND REEL INFORMATION





A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

#### QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



#### \*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74LS139ADR	SOIC	D	16	2500	330.0	16.4	6.5	10.3	2.1	8.0	16.0	Q1
SN74LS139ANSR	so	NS	16	2000	330.0	16.4	8.2	10.5	2.5	12.0	16.0	Q1



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### \*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74LS139ADR	SOIC	D	16	2500	353.0	353.0	32.0
SN74LS139ANSR	SO	NS	16	2000	356.0	356.0	35.0



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### **TUBE**



\*All dimensions are nominal

an unifersions are nonlinar											
Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)			
76007012A	FK	LCCC	20	55	506.98	12.06	2030	NA			
7600701FA	W	CFP	16	25	506.98	26.16	6220	NA			
JM38510/30702B2A	FK	LCCC	20	55	506.98	12.06	2030	NA			
JM38510/30702BFA	W	CFP	16	25	506.98	26.16	6220	NA			
JM38510/30702SFA	W	CFP	16	25	506.98	26.16	6220	NA			
M38510/30702B2A	FK	LCCC	20	55	506.98	12.06	2030	NA			
M38510/30702BFA	W	CFP	16	25	506.98	26.16	6220	NA			
M38510/30702SFA	W	CFP	16	25	506.98	26.16	6220	NA			
SN74LS139AN	N	PDIP	16	25	506	13.97	11230	4.32			
SN74LS139AN	N	PDIP	16	25	506	13.97	11230	4.32			
SN74LS139ANE4	N	PDIP	16	25	506	13.97	11230	4.32			
SN74LS139ANE4	N	PDIP	16	25	506	13.97	11230	4.32			
SN74S139AD	D	SOIC	16	40	507	8	3940	4.32			
SN74S139AN	N	PDIP	16	25	506	13.97	11230	4.32			
SN74S139AN	N	PDIP	16	25	506	13.97	11230	4.32			
SNJ54LS139AFK	FK	LCCC	20	55	506.98	12.06	2030	NA			
SNJ54LS139AW	W	CFP	16	25	506.98	26.16	6220	NA			

# W (R-GDFP-F16)

# CERAMIC DUAL FLATPACK



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only.
- E. Falls within MIL STD 1835 GDFP2-F16



8.89 x 8.89, 1.27 mm pitch

LEADLESS CERAMIC CHIP CARRIER

This image is a representation of the package family, actual package may vary. Refer to the product data sheet for package details.



# 14 LEADS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only on press ceramic glass frit seal only.
- E. Falls within MIL STD 1835 GDIP1-T14, GDIP1-T16, GDIP1-T18 and GDIP1-T20.

# N (R-PDIP-T\*\*)

# PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.





SOP



- 1. All linear dimensions are in millimeters. Dimensions in parenthesis are for reference only. Dimensioning and tolerancing
- per ASME Y14.5M.

  2. This drawing is subject to change without notice.

  3. This dimension does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.15 mm, per side.
- 4. This dimension does not include interlead flash. Interlead flash shall not exceed 0.25 mm, per side.



SOF



### NOTES: (continued)

- 5. Publication IPC-7351 may have alternate designs.
- 6. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SOF



#### NOTES: (continued)

- 7. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
- 8. Board assembly site may have different recommendations for stencil design.



# D (R-PDS0-G16)

## PLASTIC SMALL OUTLINE



- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AC.



## **MECHANICAL DATA**

# NS (R-PDSO-G\*\*)

# 14-PINS SHOWN

### PLASTIC SMALL-OUTLINE PACKAGE



- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



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